TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π–MOSIII)

2SK2749

Chopper Regulator, DC-DC Converter and Motor Drive Applications

• Low drain–source ON resistance : $R_{DS\ (ON)}$ = 1.6 Ω (typ.)

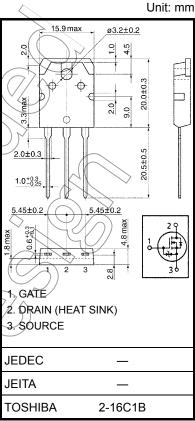
High forward transfer admittance : |Y_{fs}| = 5.0 S (typ.)

• Low leakage current : $I_{DSS} = 100 \mu A \text{ (max) (V}_{DS} = 720 \text{ V)}$

Enhancement mode : V_{th} = 2.0 to 4.0 V (V_{DS} = 10 V, I_D = 1 mA)

Absolute Maximum Ratings (Ta = 25°C)

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Characteri	stics	Symbol	Rating	(Vnit)
Drain-source voltage		V_{DSS}	900	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\
Drain-gate voltage (R	_{GS} = 20 kΩ)	V_{DGR}	900	×
Gate-source voltage		V_{GSS}	±30	> v
Drain current	DC (Note 1)	ΙD	7	Α
	Pulse (Note 1)	I _{DP}	21	A .
Drain power dissipatio	n (Tc = 25°C)	PD	150	/_(W
Single pulse avalanche	e energy (Note 2)	E _A \$	682	Ę
Avalanche current		TAR	7	A
Repetitive avalanche	energy (Note 3)	((EAR))	15	Lm/
Channel temperature		Tch	150	~c
Storage temperature r	ange	T _{stg}	-55 to 150	°C



Weight: 4.6 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristics Symbol	Max	Unit
Thermal resistance, channel to case Rth (ch-c)	0.833	°C/W
Thermal resistance, channel to ambient R _{th (ch-a)}	50	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: V_{DD} = 90 V, T_{ch} = 25°C (initial), L = 25.5 mH, I_{AR} = 7 A, R_G = 25 Ω

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device.

Please handle with caution.

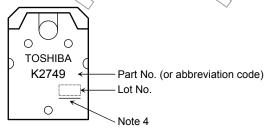
Electrical Characteristics (Ta = 25°C)

Charac	eteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	rrent	I _{GSS}	V _{GS} = ±25 V, V _{DS} = 0 V	_	_	±10	μA
Gate-source bre	eakdown voltage	V (BR) GSS	I _G = ±10 μA, V _{DS} = 0 V	±30	_	_	V
Drain cut-off cui	rrent	I _{DSS}	V _{DS} = 720 V, V _{GS} = 0 V		_	100	μA
Drain-source br	eakdown voltage	V _{(BR) DSS}	I _D = 10 mA, V _{GS} = 0 V	900		1	V
Gate threshold v	oltage	V_{th}	V _{DS} = 10 V, I _D = 1 mA	2.0) >-	4.0	V
Drain-source Ol	N resistance	R _{DS} (ON)	V _{GS} = 10 V, I _D = 3.5 A) <	1.6	2.0	Ω
Forward transfer	admittance	Y _{fs}	V _{DS} = 10 V, I _D = 3.5 A	1).25	5.0	_	S
Input capacitano	e	C _{iss}		_	1500	_	
Reverse transfer capacitance		C _{rss}	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz	· –	30	_	pF
Output capacitance		C _{oss}		_	140	_	
Switching time	Rise time	t _r	$V_{GS} \stackrel{10V}{\sim} \prod I_{D} = 3.5A$ $\stackrel{\circ}{\sim} V_{OUT}$	- (35	∕>	
	Turn-on time	t _{on}	$_{0V}$ $_{0V}$ $_{RL}$ = 114 Ω		80) —	ns
	Fall time	t _f	v _{DD} ≒400V		50	1	
	Turn-off time	t _{off}	Duty $\leq 1\%$, $t_{\rm W} = 10 \mu \rm s$) –	220	_	
Total gate charg plus gate-drain)		Qg			55		
Gate-source charge		Q _{gs}	$V_{DD} \approx 400 \text{ V}, V_{GS} = 10 \text{ V}, V_{D} = 7 \text{ A}$		30	_	nC
Gate-drain ("mil	ler") Charge	Qgd		_	25	_	

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	1 _{DR}		_	_	7	Α
Pulse drain reverse current (Note 1)	I _{DRP}	_	-	-	21	Α
Forward voltage (diode)	V _{DSF}	I _{DR} = 7 A, V _{GS} = 0 V	_	_	-1.9	V
Reverse recovery time	t _{rr}	I _{DR} = 7 A, V _{GS} = 0 V	-	1400	1	ns
Reverse recovery charge	Qrr	dl _{DR} / dt = 100 A / μs	-	14	-	μC

Marking

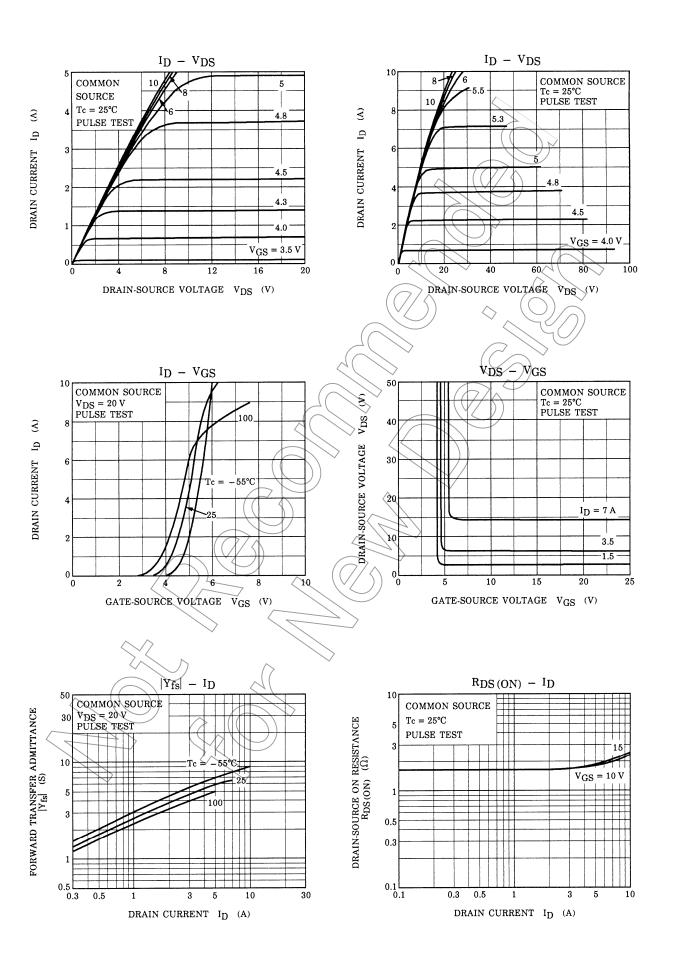


Note 4: A line under a Lot No. identifies the indication of product Labels.

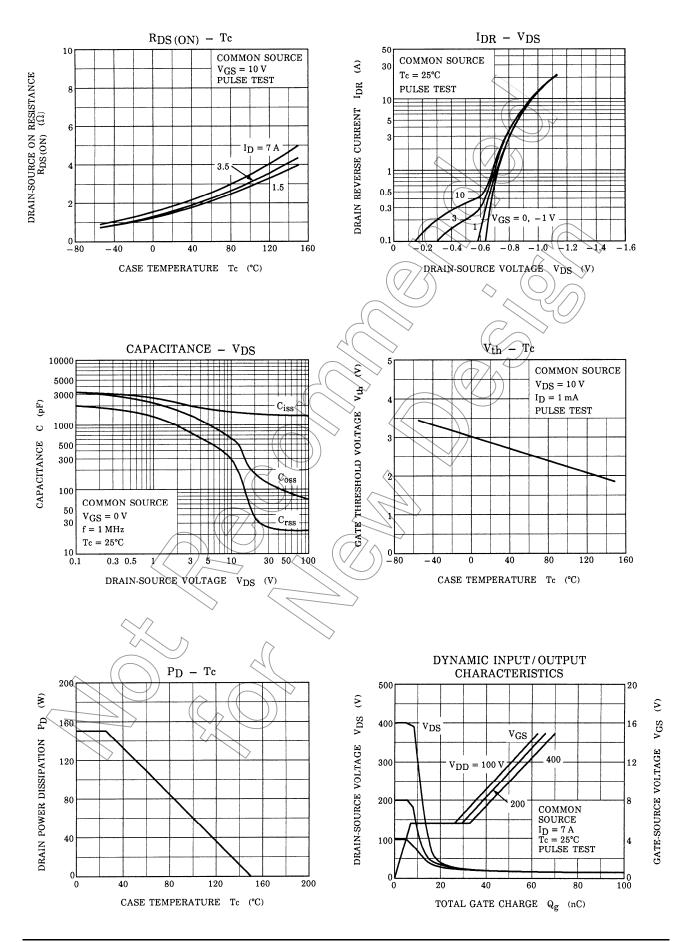
Not underlined: [[Pb]]/INCLUDES > MCV

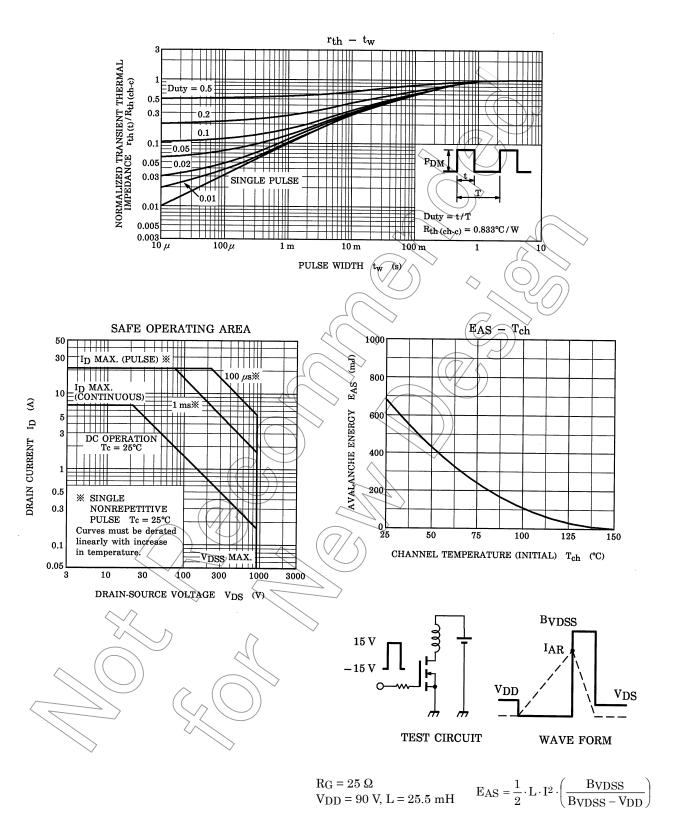
Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.



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